Displaytech
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TFT LCD Module
Product Specification

DT022CTFT
2.2" (240(RGB) x 320 PIXELS) TFT Module

November 4, 2019

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Revision Record

REV	CHANGES	DATE
1.0	First release	Jan 9, 2018
1.1	Corrected VSYNC & HSYNC pin location on section 4. Outline Drawing and section 5. Interface Signals.	Nov 4, 2019
	-	

Table of Content

1. Scope

This data sheet is to introduce the specification of DT022CTFT active matrix TFT module. It is composed of a color TFT-LCD panel, driver ICs, FPC and a backlight unit. The 2.2" display area contains 240 (RGB) x 320 pixels.

2. Application

Digital equipment which need color display, mobile navigator/video systems.

3. General Information

Item	Contents	Unit
Size	2.2	inch
Resolution	240(RGB) x 320	/
Interface	RGB/MCU	/
Technology Type	a-Si	/
Pixel Pitch	0.141 x 0.141	mm
Pixel Configuration	R.G.B. Vertical Stripe	/
Outline Dimension (W x H x D)	38.50 x 56.16 x 2.35	mm
Active Area	33.84 x 45.12	mm
Display Mode	Normally white, Transmissive	/
Viewing Direction	6 o'clock	/
Backlight Type	LED	/
Driver IC	ILI9341V	/

4. Outline Drawing

NOTES:
1. DISPLAY TYPE: 2.2" a-Si TFT
2. DISPLAY MODE: TM with Normally White
3. VIEW DIRECTION: 6 o'clock
4. OPERATION TEMPERATURE: −20°C~+70°C
STORAGE TEMPERATURE: −30°C~+80°C
5. GENERAL TOLERANCE: ±0.2
6. Driver IC: ILI9341V
7. Backlight lifetime:50000 hours(Typical)
8. REQUIREMENT ON ENVIRONMENT PROTECTION: ROHS

DISPLAYTECH
DT022CTFT

BENDING AREA

2.2"TFT
240*RGB*320

6 o'clock

RGB

Green

STIFFENER PI
CONTACT SIDE

DETAIL. A

1.2 MAX
0.3±0.05

D.S.T(T=0.15MM)

DETAIL A(2:1)
2-R0.2
W=0.35±0.03
P0.5X(45−1)=22.0±0.05
23.0±0.1
3.8±0.3
0.5±0.1

LED CIRCUIT DIAGRAM:
A
K1
K2
K3
K4

DOTS DETAIL(100:1)
R G B
0.141
0.141

LED_A
RESET

Rev.	DATE	NOTES
V1.0	2017.09.20	New issue
V1.1	2019.11.04	Modify Pin7 and Pin8 definitions

CUSTOMER P/N:

Customer Approval	Drawn:	Lucien	
	Checked:		
	Approved:		
	Critical Dim.		
	Reference Dim.	( )	
	Part No.	DT022CTFT	
	Revison	V1.1	
	Date	2019-11-04	
	Title	TFT LCM OUTLINE	
	Unit	mm	
	Scale	1:1	
	Page	1/1	
		3rd Angle	

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PIN FUCTION

PIN	SYMBOL
1	LED_K4
2	IM0
3	IM1
4	IM2
5	IM3
6	RESET
7	VSYNC
8	HSYNC
9	DOTCLK
10	ENABLE
11	DB17
12	DB16
13	DB15
14	DB14
15	DB13
16	DB12
17	DB11
18	DB10
19	DB9
20	DB8
21	DB7
22	DB6
23	DB5
24	DB4
25	DB3
26	DB2
27	DB1
28	DB0
29	SDI
30	SDO
31	RD
32	RS/SCL
33	WR
34	CS
35	FMARK
36	VCC
37	GND
38	LED_A
39	LED_K1
40	LED_K2
41	LED_K3
42	YD(NC)
43	XR(NC)
44	YU(NC)
45	XL(NC)

36.0±0.5
56.16±0.2 BL
51.92 LCD
45.12 LCD A.A
1.07
2.57
(25.13)
(19.29)
38.5±0.2 BL
36.84 LCD
33.84 LCD A.A
0.79
2.29
11.0±0.5
7.79±0.5
6.0±0.3

2.35±0.15
1.3

2-34.0
11.4
2-Φ1.0
2-2.5
36.5
1.0
1.0

5. Interface Signals

No	Symbol	Description	Remarks
1	LED-K4	LED backlight (Cathode)	
2	IM0	System interface select	Note
3	IM1	System interface select	
4	IM2	System interface select	
5	IM3	System interface select	
6	RESET	Reset signal, Active low	
7	VSYNC	Frame sync signal for RGB interface operation	
8	HSYNC	Line sync signal for RGB interface operation	
9	DOTCLK	Dot clock signal for RGB interface operation	
10	ENABLE	Data enable signal for RGB interface operation	
11 ~ 28	DB17 ~ DB0	Data bus	
29	SDO	Serial data output in serial bus system interface	
30	SDI	Serial data Input in serial bus system interface	
31	RD	Read enable pin I80 parallel bus system interface	
32	RS/SCL	RS: Data or Command select pin in parallel interface 　　When RS="1", data is selected 　　When RS="0", command is selected SCL: Serial data clock in serial bus system	
33	WR	Write enable pin in I80 parallel bus system interface	
34	CS	Chip select signal	
35	FMARK	Tearing effect output pin to synchronize MPU to frame writing	
36	VCC	Power supply	
37	GND	Ground	
38	LED-A	LED backlight (Anode)	
39	LED-K1	LED backlight (Cathode)	
40	LED-K2	LED backlight (Cathode)	
41	LED-K3	LED backlight (Cathode)	
42	YD (NC)	Touch panel pin (No connection)	
43	XR (NC)	Touch panel pin (No connection)	
44	YU (NC)	Touch panel pin (No connection)	
45	XL (NC)	Touch panel pin (No connection)	

Note:

IM3	IM2	IM1	IM0	Interface	DB Pin in use	
					Register/Content	GRAM
0	0	0	0	80 MCU 8-bit bus interface Ⅰ	DB[7:0]	DB[7:0]
0	0	0	1	80 MCU 16-bit bus interface Ⅰ	DB[7:0]	DB[15:0]
0	0	1	0	80 MCU 9-bit bus interface Ⅰ	DB[7:0]	DB[8:0]
0	0	1	1	80 MCU 18-bit bus interface Ⅰ	DB[7:0]	DB[17:0]
0	1	0	1	3-line 9-bit data serial interface Ⅰ	SDA: In/Out	
0	1	1	0	4-line 8-bit data serial interface Ⅰ	SDA: In/Out	
1	0	0	0	80 MCU 16-bit bus interface Ⅱ	DB[8:1]	DB[17:10] DB[8:1]
1	0	0	1	80 MCU 8-bit bus interface Ⅱ	DB[17:10]	DB[17:10]
1	0	1	0	80 MCU 18-bit bus interface Ⅱ	DB[8:1]	DB[17:0]
1	0	1	1	80 MCU 9-bit bus interface Ⅱ	DB[17:10]	DB[17:9]
1	1	0	1	3-line 9-bit data serial interface Ⅱ	SDI: In,　SDO: Out	
1	1	1	0	4-line 8-bit data serial interface Ⅱ	SDI: In,　SDO: Out	

6. Absolute Maximum Ratings

6.1 Electrical absolute maximum ratings

Parameter	Symbol	MIN	MAX	Unit	Remark
Power Supply Voltage	VCC	-0.3	3.6	V	

Notes:
1. If the module is above these absolute maximum ratings. It may become permanently damaged. Using the module within the following electrical characteristic conditions are also exceeded, the module will malfunction and cause poor reliability.
2. VCC > VSS must be maintained.

6.2 Environment conditions

Parameter	Symbol	MIN	MAX	Unit	Remark
Operating Temperature	TOPR	-20	+70	°C	
Storage Temperature	TSTG	-30	+80	°C	

Note:
1. The response time will become lower when operated at low temperature.
2. Background color changes slightly depending on ambient temperature.
   The phenomenon is reversible.
3. Ta<=40℃:85%RH MAX.
   Ta>=40℃:Absolute humidity must be lower than the humidity of 85%RH at 40℃.

7. Electrical Specifications

7.1 Electrical characteristics

GND=0V, Ta=25°C

Item		Symbol	MIN	TYP	MAX	Unit	Remark
Power Supply		VCC	2.6	2.8	3.3	V	Ta=25°C
Input Signal Voltage	Low Level	VIL	0	-	0.2VCC	V	VCC=2.8V
	High Level	VIH	0.8VCC	-	VCC	V	VCC=2.8V
Current Consumption		ICC1	-	5	10	mA	Normal mode
		ICC2	-	0.05	0.1	mA	Sleep mode

Note: Tested in 1✕1 chessboard pattern.

7.2 LED backlight

Ta=25°C

Item	Symbol	MIN	TYP	MAX	Unit	Remark
Forward current	IF	-	60	-	mA	
Forward voltage	VF	-	3.0	-	V	
LED life time	-	-	50,000	-	Hrs	Note

Note : The "LED life time" is defined as the module brightness decrease to 50% original brightness at Ta=25℃ and IL =60mA. The LED lifetime could be decreased if operating IL is larger than 60mA.
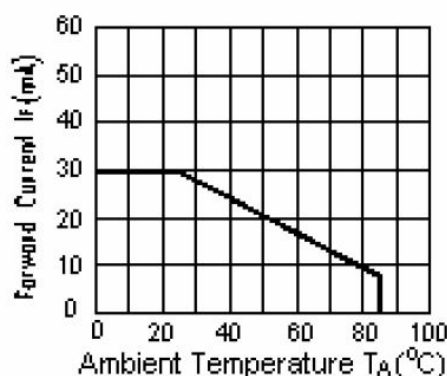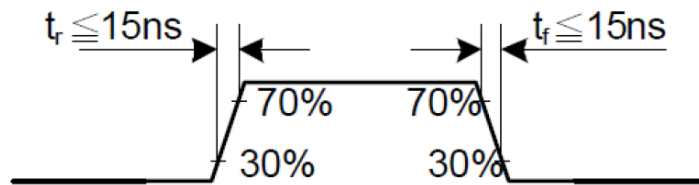
8. Command/AC Timing

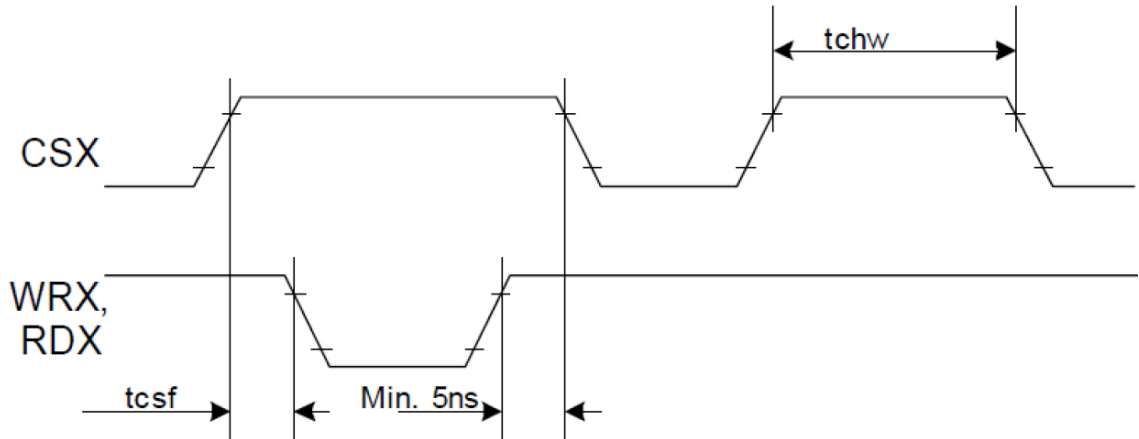## 8.1 Display Parallel 18/16/9/8-bit Interface Timing Characteristics (8080-I system)

Signal	Symbol	Parameter	Min.	Max.	Unit	Description
DCX	tast	Address setup time	0	-	ns	
	taht	Address hold time (Write/Read)	0	-	ns	
CSX	tchw	CSX "H" pulse width	0	-	ns	
	tcs	Chip Select setup time (Write)	15	-	ns	
	trcs	Chip Select setup time (Read ID)	45	-	ns	
	trcsfm	Chip Select setup time (Read FM)	355	-	ns	
	tcsf	Chip Select Wait time (Write/Read)	10	-	ns	
WRX	twc	Write cycle	66	-	ns	
	twrh	Write Control pulse H duration	15	-	ns	
	twrl	Write Control pulse L duration	15	-	ns	
RDX(FM)	trcfm	Read Cycle (FM)	450	-	ns	
	trdhfm	Read Control H duration (FM)	90	-	ns	
	trdlfm	Read Control L duration (FM)	355	-	ns	
RDX(ID)	trc	Read cycle (ID)	160	-	ns	
	trdh	Read Control pulse H duration	90	-	ns	
	trdl	Read Control pulse L duration	45	-	ns	
D[17:0] D[15:0] D[8:0] D[7:0]	tdst	Write data setup time	10	-	ns	For maximum CL=30pF For minimum CL=8pF
	tdht	Write data hold time	10	-	ns	
	trat	Read access time	-	40	ns	
	tratfm	Read access time	-	340	ns	
	trod	Read output disable time	20	80	ns	

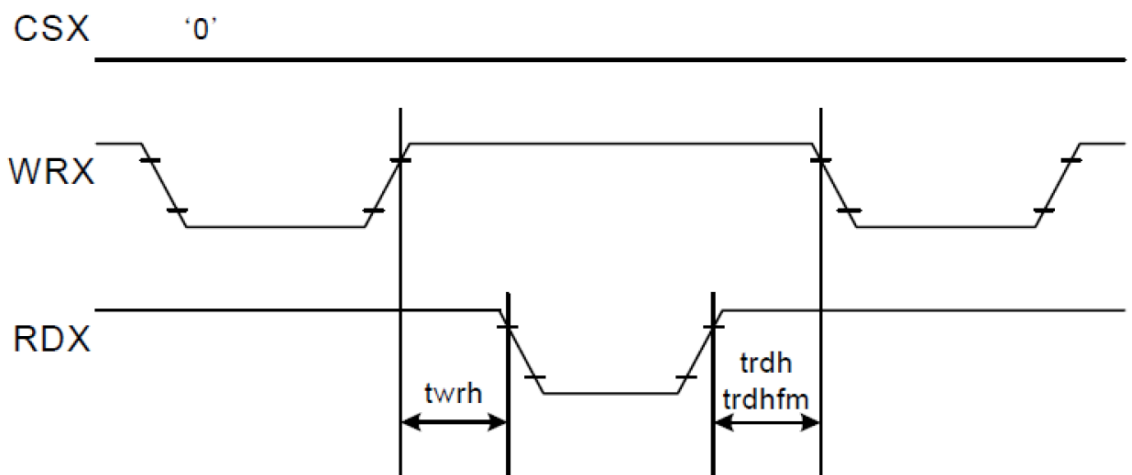Note 1: Ta= -30 to 70℃, VDDI=1.65 to 3.3V, VCI=2.5 to 3.3V, VSS=0V.
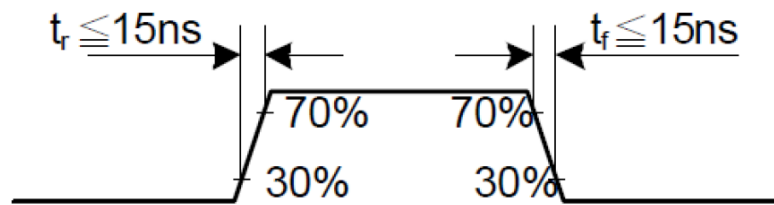
CSX timings:

Note: Logic high and low levels are specified as 30% and 70% of VDDI for input signals.

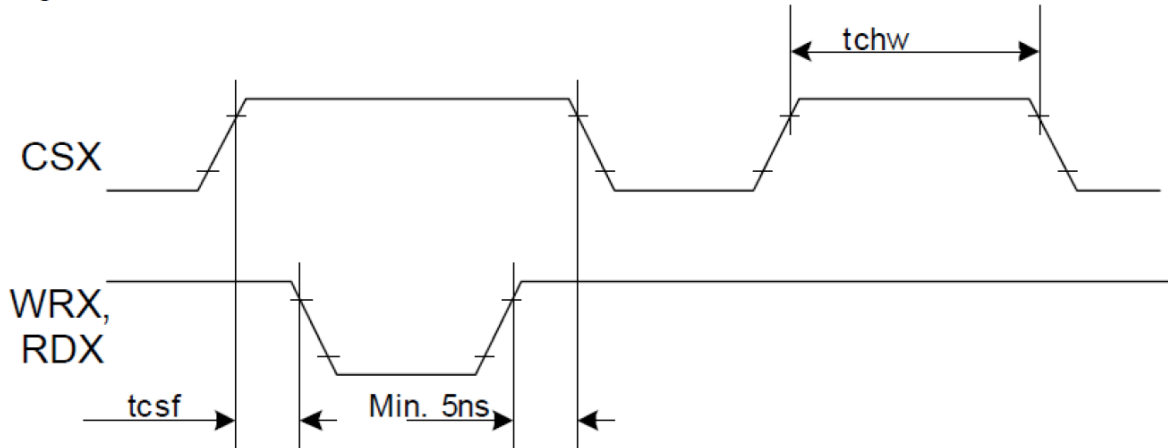Write to read or read to write timings:

Note: Logic high and low levels are specified as 30% and 70% of VDDI for input signals.

8.2 Display Parallel 18/16/9/8-bit Interface Timing Characteristics (8080-II system)

Signal	Symbol	Parameter	Min.	Max.	Unit	Description
DCX	tast	Address setup time	0	-	ns	
	taht	Address hold time (Write/Read)	0	-	ns	
CSX	tchw	CSX "H" pulse width	0	-	ns	
	tcs	Chip Select setup time (Write)	15	-	ns	
	trcs	Chip Select setup time (Read ID)	45	-	ns	
	trcsfm	Chip Select setup time (Read FM)	355	-	ns	
	tcsf	Chip Select Wait time (Write/Read)	10	-	ns	
WRX	twc	Write cycle	66	-	ns	
	twrh	Write Control pulse H duration	15	-	ns	
	twrl	Write Control pulse L duration	15	-	ns	
RDX(FM)	trcfm	Read Cycle (FM)	450	-	ns	
	trdhfm	Read Control H duration (FM)	90	-	ns	
	trdlfm	Read Control L duration (FM)	355	-	ns	
RDX(ID)	trc	Read cycle (ID)	160	-	ns	
	trdh	Read Control pulse H duration	90	-	ns	
	trdl	Read Control pulse L duration	45	-	ns	
D[17:0] D[17:0]&D[8:1] D[17:10] D[17:9]	tdst	Write data setup time	10	-	ns	For maximum CL=30pF For minimum CL=8pF
	tdht	Write data hold time	10	-	ns	
	trat	Read access time	-	40	ns	
	tratfm	Read access time	-	340	ns	
	trod	Read output disable time	20	80	ns	

Note 1: Ta= -30 to 70℃, VDDI=1.65 to 3.3V, VCI=2.5 to 3.3V, VSS=0V.

$t_r \leqq 15ns$ $t_f \leqq 15ns$

70%   70%

30%   30%

CSX timings:

tchw

CSX

WRX,
RDX

tcsf   Min. 5ns

Note: Logic high and low levels are specified as 30% and 70% of VDDI for input signals.

Write to read to read to write timings:

CSX   '0'

WRX

RDX

twrh

trdh
trdhfm
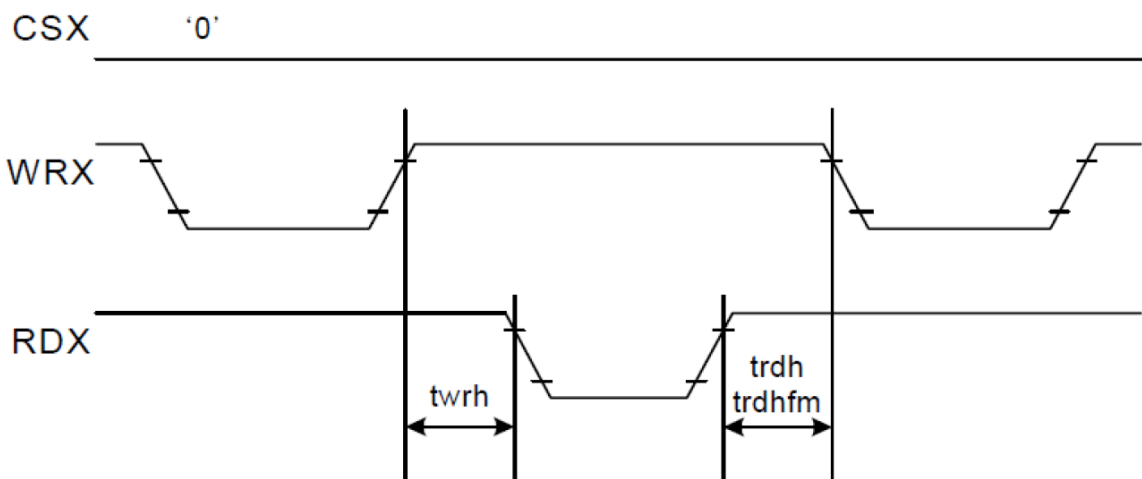
Note: Logic high and low levels are specified as 30% and 70% of VDDI for input signals.

8.3 Parallel 18/16/6-bit RGB Interface Timing Characteristics
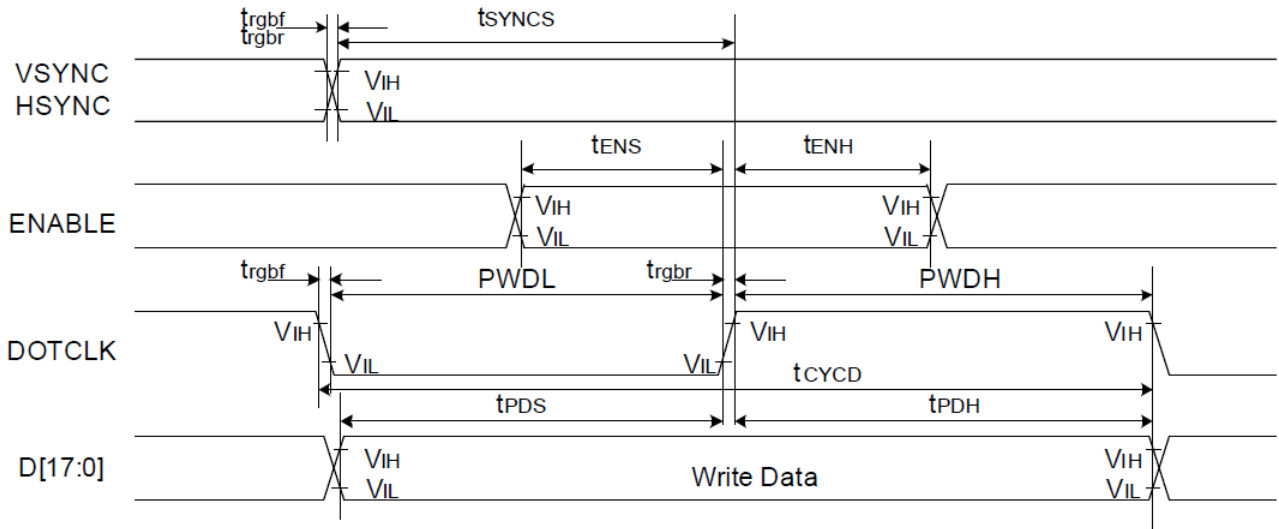
Signal	Symbol	Parameter	Min.	Max.	Unit	Description
VSYNC/ HSYNC	t_{SYNCS}	VSYNC/HSYNC setup time	15	-	ns	18/16-bit bus RGB interface mode
	t_{SYNCH}	VSYNC/HSYNC hold time	15	-	ns	
DE	t_{ENS}	DE setup time	15	-	ns	
	t_{ENH}	DE hold time	15	-	ns	
D[17:0]	t_{POS}	Data setup time	15	-	ns	
	t_{PDH}	Data hold time	15	-	ns	
DOTCLK	PWDH	DOTCLK high-level period	15	-	ns	
	PWDL	DOTCLK low-level period	15	-	ns	
	t_{CYCD}	DOTCLK cycle time	100	-	ns	
	trgbr,trgbf	DOTCLK,HSYNC,VSYNC rise/fall time	-	15	ns	
VSYNC/ HSYNC	t_{SYNCS}	VSYNC/HSYNC setup time	15	-	ns	6-bit bus RGB interface mode
	t_{SYNCH}	VSYNC/HSYNC hold time	15	-	ns	
DE	t_{ENS}	DE setup time	15	-	ns	
	t_{ENH}	DE hold time	15	-	ns	
D[17:0]	t_{POS}	Data setup time	15	-	ns	
	t_{PDH}	Data hold time	15	-	ns	
DOTCLK	PWDH	DOTCLK high-level period	15	-	ns	
	PWDL	DOTCLK low-level period	15	-	ns	
	t_{CYCD}	DOTCLK cycle time	50	-	ns	
	trgbr,trgbf	DOTCLK,HSYNC,VSYNC rise/fall time	-	15	ns	

Note 1: Ta= -30 to 70℃, VDDI=1.65 to 3.3V, VCI=2.5 to 3.3V, AGND=VSS=0V.
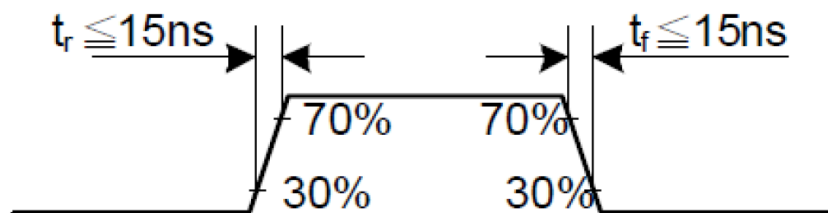
9. Optical Specification

Item		Symbol	Condition	MIN	TYP	MAX	Unit	Remark
Contrast ratio		CR	θ=0°	300	500	-		Note 1, 2
Response time		Tr	25°C	-	10	-	ms	Note 1, 3
		Tf		-	10	-		
View angles		ΘT	CR≧10	-	55	-	Degree	Note 4
		ΘB		-	65	-		
		ΘL		-	65	-		
		ΘR		-	65	-		
Chromaticity	White	x	Brightness is on	-	0.28	-		Note 1, 5
		y		-	0.33	-		
	Red	x		-	0.51	-		
		y		-	0.34	-		
	Green	x		-	0.31	-		
		y		-	0.56	-		
	Blue	x		-	0.15	-		
		y		-	0.14	-		
NTSC Ratio		S		50	60		%	Note 1, 5
Luminance		L		250	330	-	cd/m^2	Note 1, 6
Uniformity		U		-	80	-	%	Note 1, 7

Note 1: Definition of optical measurement system.

Temperature = 25℃(±3℃)

LED back-light: ON, Environment brightness < 150 lx
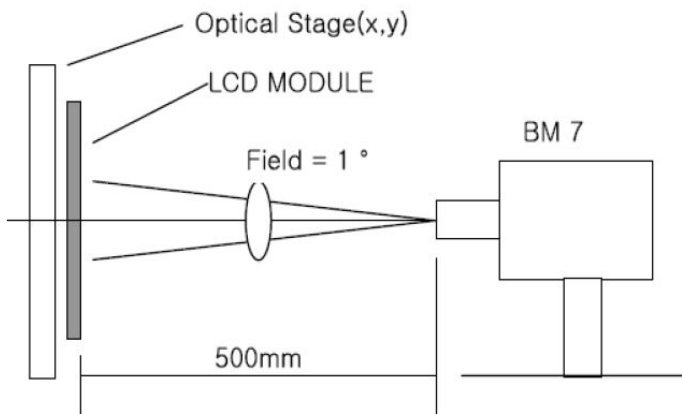
Note 2: Contrast ratio is defined as follow:

$$\text{Contrast Ratio} = \frac{\text{Surface Luminance with all white pixels}}{\text{Surface Luminance with all black pixels}}$$

Note 3: Response time is defined as follow:

Response time is the time required for the display to transition from black to white (Rise time, Tr) and from white to black (Decay Time, Tf).
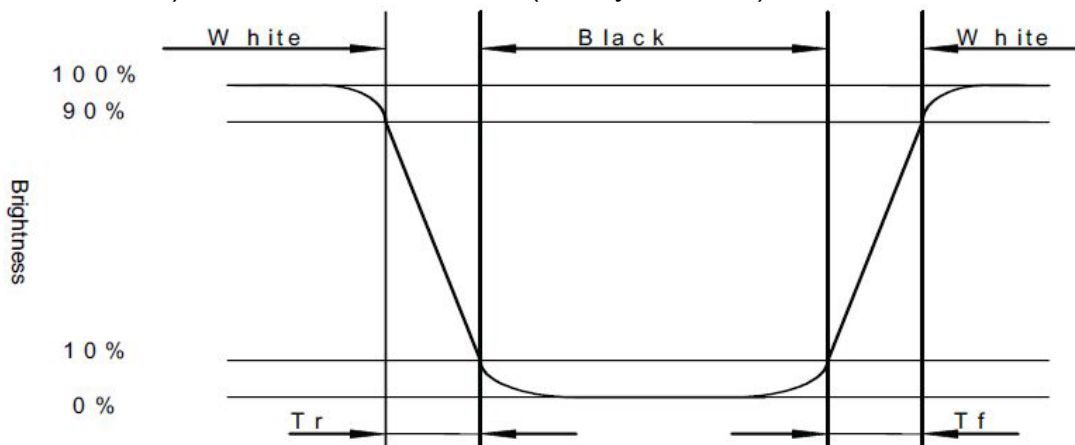
Note 4: Viewing angle range is defined as follow:

Viewing angle is measured at the center point of the LCD.
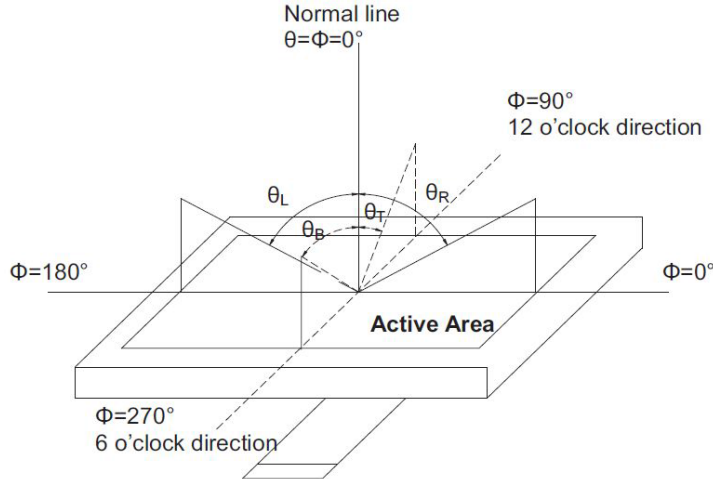
Note 5: Color chromaticity is defined as follow (CIE1931)

Color coordinates measured at center point of LCD.
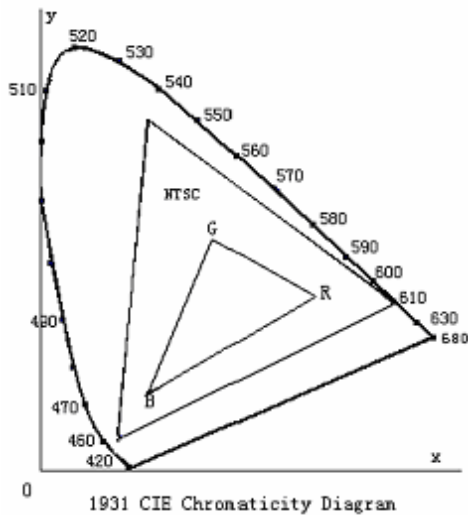
$$S = \frac{\text{area of RGB triangle}}{\text{area of NTSC triangle}} \times 100\%$$

Note 6: Luminance is defined as follow:

Luminance is defined as the brightness of all pixels "White" at the center of display area on optimum contrast.

Note 7: Luminance Uniformity is defined as follow:

Active area is divided into 9 measuring areas (Refer Fig.2). Every measuring point is placed at the center of each measuring area.

$$\text{Uniformity (U)} = \frac{\text{Minimum Luminance(brightness) in 9 points}}{\text{Maximum Luminance(brightness) in 9 points}}$$
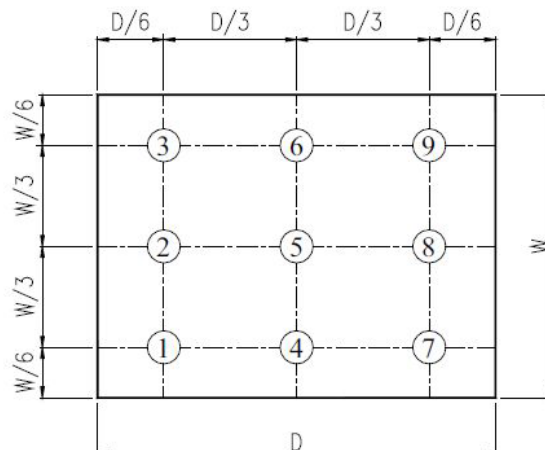

Fig. 2 Definition of uniformity

10. Environmental / Reliability Tests

No	Test Item	Condition	Judgment Criteria
1	High Temp Operation	Ta=+70°C, 96hrs	Per table below
2	Low Temp Operation	Ta=-20°C, 96hrs	Per table below
3	High Temp Storage	Ta=+80°C, 96hrs	Per table below
4	Low Temp Storage	Ta=-30°C, 96hrs	Per table below
5	High Temp & High Humidity Storage	Ta=+60°C, 90% RH, 96hrs	Per table below (polarizer discoloration is excluded)
6	Thermal Shock (Non-operation)	-30℃ 30 min~+70℃ 30 min, Change time: 5min, 10 Cycles	Per table below
7	ESD (Operation)	C=150pF, R=330Ω, 5points/panel Air:±8KV, 5times; Contact:±4KV, 5 times;	Per table below
8	Vibration (Non-operation)	Frequency range: 10~55Hz, Stroke: 1.5mm Sweep: 10Hz~55Hz~10Hz 2 hours for each direction of X.Y.Z.	Per table below
9	Shock (Non-operation)	60G 6ms, ±X,±Y,±Z 3times, for each direction	Per table below
10	Package Drop Test	Height: 80cm, 1 corner, 3 edges, 6 surfaces	Per table below

Inspection	Criterion (after test)
Appearance	No crack on the FPC, on the LCD panel
Alignment of LCD panel	No bubbles in the LCD panel No other defects of alignment in active area
Electrical current	Within device specifications
Function / Display	No broken circuit, no short circuit or no black line No other defects of display

11. Precautions for Use of LCD Modules

11.1 Safety

The liquid crystal in the LCD is poisonous. Do not put it in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and water.

11.2 Handling

a. The LCD and touch panel is made of plate glass. Do not subject the panel to mechanical shock or to excessive force on its surface.

b. Do not handle the product by holding the flexible pattern portion in order to assure the reliability.

c. Transparency is an important factor for the touch panel. Please wear clear finger sacks, gloves and mask to protect the touch panel from finger print or stain and also hold the portion outside the view area when handling the touch panel.

d. Provide a space so that the panel does not come into contact with other components.

e. To protect the product from external force, put a covering lens (acrylic board or similar board) and keep an appropriate gap between them.

f. Transparent electrodes may be disconnected if the panel is used under environmental conditions where dew condensation occurs.

g. Property of semiconductor devices may be affected when they are exposed to light, possibly resulting in IC malfunctions.

h. To prevent such IC malfunctions, your design and mounting layout shall be done in the way that the IC is not exposed to light in actual use.

11.3 Static electricity

a. Ground soldering iron tips, tools and testers when they are in operation.
b. Ground your body when handling the products.
c. Power on the LCD module before applying the voltage to the input terminals.
d. Do not apply voltage which exceeds the absolute maximum rating.
e. Store the products in an anti-electrostatic bag or container.

11.4 Storage

a. Store the products in a dark place at +25°C±10°C with low humidity (40% RH to 60% RH). Don't expose to sunlight or fluorescent light.
b. Storage in a clean environment, free from dust, active gas, and solvent.

10.5 Cleaning

a. Do not wipe the touch panel with dry cloth, as it may cause scratch.
b. Wipe off the stain on the product by using soft cloth moistened with ethanol. Do not allow ethanol to get in between the upper film and the bottom glass. It may cause peeling issue or defective operation. Do not use any organic solvent or detergent other than ethanol.

11.6 Cautions for installing and assembling

a. Bezel edge must be positioned in the area between the Active area and View area. The bezel may press the touch screen and cause activation if the edge touches the active area. A gap of approximately 0.5mm is needed between the bezel and the top electrode. It may cause unexpected activation if the gap is too narrow. There is a tolerance of 0.2 to 0.3mm for the outside dimensions of the touch panel and tail. A gap must be made to absorb the tolerance in the case and connector.
b. In order to make the display assembly stable and firm, Displaytech recommends to design some supporting at the display backside, especially for the display with tape-attached touch panel, such supporting is important and essential, or else, the display may drop-off from front after some period of time.
c. Do not display the fixed pattern for a long time because it may develop image sticking due to the LCD structure. If the screen is displayed with fixed pattern, use a screen saver.